## Amendments to the claims:

Cancel claims 1, 2, 3, 4, 5, 15 and 25.

Claims 6, 16 and 16 are amended.

New claims 44-52 are added.

## 1.- 5. (Cancelled)

1	6. (Currently Amended) A spin valve transistor as claimed in claim 4 wherein A spin		
2	valve transistor comprising:		
3	an emitter;		
4	a collector;		
5	a base between the emitter and the collector;		
6	a spin valve including:		
7	a ferromagnetic free layer structure:		
8	a self-pinned antiparallel (AP) pinned layer structure without any pinning structure		
9	pinning the self-pinned AP pinned layer structure; and		
10	a nonmagnetic spacer layer between the free layer structure and the AP pinned layer		
11	structure; and		
12	the base comprising at least said free layer structure;		
13	the self pinned AP pinned layer structure comprising:		
14	a ferromagnetic first antiparallel (AP) pinned layer;		
15	a ferromagnetic second antiparallel (AP) pinned layer;		
16	a nonmagnetic antiparallel coupling (APC) layer located between the first and		
17	second AP pinned layers:		
18	one of the first and second AP pinned layers having a cobalt iron (CoFe) film with		
19	a positive magnetostriction;		
20	the CoFe film having a magnetostrictive anisotropy field that is oriented		
21	perpendicular to a head surface of the spin valve transistor for self pinning the AP pinned		
22	layer structure; and		
23	the first and second AP pinned layers [[have]] having the same magnetic thickness.		

7. (Previously Presented) A spin valve transistor comprising:				
an emitter;				
a collector;				
a base between the emitter and the collector;				
a spin valve including:				
a ferromagnetic free layer structure composed of iron (Fe);				
a self-pinned antiparallel (AP) pinned layer structure;				
a nonmagnetic spacer layer between the free layer structure and the AP pinned layer				
structure; and				
the free layer structure interfacing the spacer layer;				
the base comprising at least said free layer structure;				
the self pinned AP pinned layer structure including:				
a ferromagnetic first antiparallel (AP) pinned layer;				
a ferromagnetic second antiparallel (AP) pinned layer; and				
a nonmagnetic antiparallel coupling (APC) layer located between the first and				
second AP pinned layers;				
the first AP pinned layer being composed of iron (Fe) and interfacing the spacer layer;				
the second AP pinned layer including:				
an iron (Fe) film;				
a cobalt iron (CoFe) film with a positive magnetostriction;				
the iron (Fe) film being located between and interfacing the APC layer and the				
cobalt iron (CoFe) film; and				
the CoFe film having a magnetostrictive anisotropy field that is oriented				
perpendicular to a head surface of the spin valve transistor for self pinning the AP pinned				
layer structure.				
8. (Original) A spin valve transistor as claimed in claim 7 wherein the cobalt iron				
is $Co_{90-50}Fe_{10-50}$ .				

1	(Freviously Fresented) A spin valve transistor as claimed in claim 7 wherein the					
2	cobalt iron (CoFe) film is Co <sub>50</sub> Fe <sub>50</sub> .					
1	10. (Original) A spin valve transistor as claimed in claim 9 wherein the first and					
2	second AP pinned layers have the same magnetic thickness.					
1	11. (Withdrawn) A spin valve transistor as claimed in claim 4 further comprising:					
2	the second AP pinned layer being composed of iron (Fe);					
3	the first AP pinned layer including:					
4	first and second iron (Fe) films with the first iron (Fe) film interfacing the spacer					
5	layer;					
6	said cobalt iron (CoFe) film; and					
7	the cobalt iron (CoFe) film being located between and interfacing the first and					
8	second iron (Fe) films.					
l	12. (Withdrawn) A spin valve transistor as claimed in claim 11 wherein the cobalt					
2	iron film is $Co_{90-50}Fe_{10-50}$ .					
1	13. (Withdrawn) A spin valve transistor as claimed in claim 12 wherein the cobalt					
2	iron film is $Co_{50}Fe_{50}$ .					
1	14. (Withdrawn) A spin valve transistor as claimed in claim 13 wherein the first and					
2	second AP pinned layers have the same magnetic thickness.					
	15. (Cancelled)					
1	16. (Currently Amended) A magnetic head assembly as claimed in claim-15 wherein					
2	A magnetic head assembly comprising:					
3	a write head;					
4	a read head adjacent the write head;					
5	the read head including:					
6	ferromagnetic first and second shield layers, and					
7	a spin valve transistor located between the first and second shield layers;					

8	the spin valve transistor comprising:				
9	an emitter;				
10	a collector;				
11	a base between the emitter and the collector;				
12	a spin valve including:				
13	a ferromagnetic free layer structure;				
14	a self-pinned antiparallel (AP) pinned layer structure without any pinning				
15	structure pinning the self-pinned AP pinned layer structure;				
16	a nonmagnetic spacer layer between the free layer structure and the AP				
17	pinned layer structure; and				
18	the base comprising at least said free layer structure;				
19	the self pinned AP pinned layer structure comprises: comprising:				
20	a ferromagnetic first antiparallel (AP) pinned layer;				
21	a ferromagnetic second antiparallel (AP) pinned layer;				
22	a nonmagnetic antiparallel coupling (APC) layer located between the first and				
23	second AP pinned layers;				
24	one of the first and second AP pinned layers having a cobalt iron (CoFe) film with				
25	a positive magnetostriction; [[and]]				
26	the CoFe film having a magnetostrictive anisotropy field that is oriented				
27	perpendicular to a head surface of the spin valve transistor for self pinning the AP pinned				
28	layer structure[[.]]; and				
29	the first and second AP pinned layers having the same magnetic thickness.				
1	17. (Previously Presented) A magnetic head assembly comprising:				
2	a write head;				
3	a read head adjacent the write head;				
4	the read head including:				
5	ferromagnetic first and second shield layers; and				
6	a spin valve transistor located between the first and second shield layers;				
7	the spin valve transistor comprising:				
8	an emitter;				
9	a collector;				
10	a base between the emitter and the collector;				

11	a spin valve including:				
12	a ferromagnetic free layer structure composed of iron (Fe);				
13	a self-pinned antiparallel (AP) pinned layer structure;				
14	a nonmagnetic spacer layer between the free layer structure and the AF				
15	pinned layer structure; and				
16	the free layer structure interfacing the spacer layer;				
17	the base comprising at least said free layer structure;				
18	the self pinned AP pinned layer structure including:				
19	a ferromagnetic first antiparallel (AP) pinned layer;				
20	a ferromagnetic second antiparallel (AP) pinned layer; and				
21	a nonmagnetic antiparallel coupling (APC) layer located between the first and				
22	second AP pinned layers;				
23	the first AP pinned layer being composed of iron (Fe) and interfacing the spacer layer;				
24	the second AP pinned layer including:				
25	an iron (Fe) film;				
26	a cobalt iron (CoFe) film with a positive magnetostriction;				
27	the iron (Fe) film being located between and interfacing the APC layer and the				
28	cobalt iron (CoFe) film; and				
29	the CoFe film having a magnetostrictive anisotropy field that is oriented				
30	perpendicular to a head surface of the spin valve transistor for self pinning the AP pinned				
31	layer structure.				
1	18. (Previously Presented) A magnetic head assembly as claimed in claim 17 wherein				
2	the cobalt iron is Co <sub>90-50</sub> Fe <sub>10-50</sub> .				
1	19. (Previously Presented) A magnetic head assembly as claimed in claim 17 wherein				
2	the cobalt iron is Co <sub>50</sub> Fe <sub>50</sub> .				
1	20. (Original) A magnetic head assembly as claimed in claim 19 wherein the first				
2	and second AP pinned layers have the same magnetic thickness.				

1	21.	(Withdrawn) A magnetic head assembly as claimed in claim 16 further				
2	comprising:					
3	the se	cond AP pinned layer being composed of iron (Fe);				
4	the fir	st AP pinned layer including:				
5		first and second iron (Fe) films with the first iron (Fe) film interfacing the spacer				
6	layer;					
7		said cobalt iron (CoFe) film; and				
8	the cobalt iron (CoFe) film being located between and interfacing the first and					
9	second iron (Fe) film.					
1	22.	(Withdrawn) A magnetic head assembly as claimed in claim 21 wherein the				
2	cobalt iron fil	m is $Co_{90-50}Fe_{10-50}$ .				
1	23.	(Withdrawn) A magnetic head assembly as claimed in claim 22 wherein the cobalt				
2	iron film is Co	$o_{50}Fe_{50}$ .				
1	24.	(Withdrawn) A magnetic head assembly as claimed in claim 23 wherein the first				
2	and second AP pinned layers have the same magnetic thickness.					
	25.	(Cancelled)				
1	26.	(Currently Amended) A magnetic disk drive as claimed in claim 25 wherein A				
2	magnetic disk drive comprising:					
3	at least one magnetic head assembly that has a head surface;					
4	the magnetic head assembly having a write head and a read head;					
5	the read head including:					
6		ferromagnetic first and second shield layers; and				
7	a spin valve transistor located between the first and second shield layers;					
8	the spin valve transistor comprising:					
9	an emitter;					
10	a collector;					
11	a base between the emitter and the collector;					

12	a spin valve including.				
13	a ferromagnetic free layer structure;				
14	a self-pinned antiparallel (AP) pinned layer structure without any pinning structure				
15	pinning the self-pinned AP pinned layer structure;				
16	a nonmagnetic spacer layer between the free layer structure and the AP pinned layer				
17	structure; and				
18	the base comprising at least said free layer structure;				
19	the self pinned AP pinned layer structure comprises: comprising:				
20	a ferromagnetic first antiparallel (AP) pinned layer;				
21	a ferromagnetic second antiparallel (AP) pinned layer;				
22	a nonmagnetic antiparallel coupling (APC) layer located between the first and				
23	second AP pinned layers;				
24	one of the first and second AP pinned layers having a cobalt iron (CoFe) film with				
25	a positive magnetostriction; [[and]]				
26	the CoFe film having a magnetostrictive anisotropy field that is oriented				
27	perpendicular to a head surface of the spin valve transistor for self pinning the AP pinned				
28	layer structure[[.]], and				
29	the first and second AP pinned layers having the same magnetic thickness;				
30	a housing:				
31	a magnetic medium supported in the housing.				
32	a support mounted in the housing for supporting the magnetic head assembly with said head				
33	surface facing the magnetic medium so that the magnetic head assembly is in a transducing				
34	relationship with the magnetic medium;				
35	a motor for moving the magnetic medium; and				
36	a processor connected to the magnetic head assembly and to the motor for exchanging				
37	signals with the magnetic head assembly and for controlling movement of the magnetic medium.				
1	27. (Previously Presented) A magnetic disk drive comprising:				
2	at least one magnetic head assembly that has a head surface;				
3	the magnetic head assembly having a write head and a read head;				
4	the read head including:				
5	ferromagnetic first and second shield layers; and				
6	a spin valve transistor located between the first and second shield layers;				

7	the spin valve transistor comprising:		
8	an emitter;		
9	a collector;		
10	a base between the emitter and the collector;		
11	a spin valve including:		
12	a ferromagnetic free layer structure composed of iron (Fe);		
13	a self-pinned antiparallel (AP) pinned layer structure;		
14	a nonmagnetic spacer layer between the free layer structure and the AP pinned layer		
15	structure; and		
16	the free layer structure interfacing the spacer layer;		
17	the base comprising at least said free layer structure,		
18	the self pinned AP pinned layer structure including:		
19	a ferromagnetic first antiparallel (AP) pinned layer;		
20	a ferromagnetic second antiparallel (AP) pinned layer, and		
21	a nonmagnetic antiparallel coupling (APC) layer located between the first and		
22	second AP pinned layers;		
23	the first AP pinned layer being composed of iron (Fe) and interfacing the spacer layer;		
24	the second AP pinned layer including:		
25	an iron (Fe) film with a positive magnetostriction;		
26	a cobalt iron (CoFe) film;		
27	the iron (Fe) film being located between and interfacing the APC layer and the		
28	cobalt iron (CoFe) film; and		
29	the CoFe film having a magnetostrictive anisotropy field that is oriented		
30	perpendicular to a head surface of the spin valve transistor for self pinning the AP pinned		
31	layer structure;		
32	a housing;		
33	a magnetic medium supported in the housing;		
34	a support mounted in the housing for supporting the magnetic head assembly with said head		
35	surface facing the magnetic medium so that the magnetic head assembly is in a transducing		
36	relationship with the magnetic medium;		
37	a motor for moving the magnetic medium; and		
38	a processor connected to the magnetic head assembly and to the motor for exchanging		
39	signals with the magnetic head assembly and for controlling movement of the magnetic medium.		

l	28.	(Original) A	magnetic	disk drive as claimed in claim 27 wherein the cobalt iron	
2	is $Co_{90-50}Fe_{10-50}$ .				
1	20	(Description of the Description	· · · · · · · · · · · · · · · · · · ·	A magnetic diele drive as alaimed in alaim 27 wherein the	
i -	29.	(Previously Pres	semea)	A magnetic disk drive as claimed in claim 27 wherein the	
2	cobalt iron is	Co <sub>50</sub> Fe <sub>50</sub> .			
1	30.	(Original)	A magne	tic disk drive as claimed in claim 29 wherein the first and	
2	second AP pinned layers have the same magnetic thickness.				
	•	•			
1	31.	(Withdrawn)	A mag	netic disk drive as claimed in claim 26 further comprising:	
2	the second AP pinned layer being composed of iron (Fe);				
3	the fir	st AP pinned laye	er includi	ng:	
4	first and second iron (Fe) films with the first iron (Fe) layer film interfacing the				
5	spacer layer;				
6	said cobalt iron (CoFe) film, and				
7		the cobalt iron	(CoFe)	film being located between and interfacing the first and	
8	second iron (Fe) film.				
1	32.	(Withdrawn)	A mag	netic disk drive as claimed in claim 31 wherein the cobalt	
2	iron is Co <sub>90-50</sub>	Fe <sub>10-50</sub> .			
1	33.	(Withdrawn)	A mag	netic disk drive as claimed in claim 32 wherein the cobalt	
2	iron is Co <sub>50</sub> Fe	e <sub>50</sub> .			
_	2.4	(TTT: 1 1 )		at 11.1 11. At 11. At 11. At 12. Of and and and	
1	34.	(Withdrawn)	_	netic disk drive as claimed in claim 33 wherein the first and	
2	second AP pi	inned layers have	the same	magnetic thickness.	

base further comprises the self-pinned antiparallel (AP) pinned layer structure and the spacer layer.

(Previously Presented)

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A spin valve transistor as claimed in claim 9 wherein the

36. (Previously Presented) A spin valve transistor as claimed in claim 35 further comprising a barrier layer located between the emitter and the base for conducting hot electrodes from the emitter to the base wherein the hot electrons have an energy level above Fermi levels of the layers in said base.

- 37. (Previously Presented) A spin valve transistor as claimed in claim 36 wherein the first and second AP pinned layers have the same magnetic thickness.
- 38. (Previously Presented) A magnetic head assembly as claimed in claim 19 wherein the base further comprises the self-pinned antiparallel (AP) pinned layer structure and the spacer layer.
- 39. (Previously Presented) A magnetic head assembly as claimed in claim 38 further comprising a barrier layer located between the emitter and the base for conducting hot electrodes from the emitter to the base wherein the hot electrons have an energy level above Fermi levels of the layers in said base.
- 40. (Previously Presented) A magnetic head assembly as claimed in claim 39 wherein the first and second AP pinned layers have the same magnetic thickness.
- 41. (Previously Presented) A magnetic disk drive as claimed in claim 29 wherein the base further comprises the self-pinned antiparallel (AP) pinned layer structure and the spacer layer.
- 42. (Previously Presented) A magnetic disk drive as claimed in claim 41 further comprising a barrier layer located between the emitter and the base for conducting hot electrodes from the emitter to the base wherein the hot electrons have an energy level above Fermi levels of the layers in said base.
- 43. (Previously Presented) A magnetic disk drive as claimed in claim 42 wherein the first and second AP pinned layers have the same magnetic thickness.

1 44. (New) A spin valve transistor as claimed in claim 6 wherein at least one of the AP pinned layers is Co<sub>so</sub>Fe<sub>so</sub>.

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- 45. (New) A spin valve transistor as claimed in claim 44 wherein the base further comprises the self-pinned antiparallel (AP) pinned layer structure and the spacer layer.
- 46. (New) A spin valve transistor as claimed in claim 45 further comprising a barrier layer located between the emitter and the base for conducting hot electrodes from the emitter to the base wherein the hot electrons have an energy level above Fermi levels of the layers in said base.
- 1 47. (New) A magnetic head assembly as claimed in claim 16 wherein at least one of the AP pinned layers is Co<sub>50</sub>Fe<sub>50</sub>.
  - 48. (New) A magnetic head assembly as claimed in claim 47 wherein the base further comprises the self-pinned antiparallel (AP) pinned layer structure and the spacer layer.
  - 49. (New) A magnetic head assembly as claimed in claim 48 further comprising a barrier layer located between the emitter and the base for conducting hot electrodes from the emitter to the base wherein the hot electrons have an energy level above Fermi levels of the layers in said base.
- 1 50. (New) A magnetic disk drive as claimed in claim 26 wherein at least one of the AP pinned layers is Co<sub>50</sub>Fe<sub>50</sub>.
  - 51. (New) A magnetic disk drive as claimed in claim 50 wherein the base further comprises the self-pinned antiparallel (AP) pinned layer structure and the spacer layer.
- 1 52. (New) A magnetic disk drive as claimed in claim 51 further comprising a barrier 2 layer located between the emitter and the base for conducting hot electrodes from the emitter to 3 the base wherein the hot electrons have an energy level above Fermi levels of the layers in said 4 base.